

**PATENT APPLICATION****IN THE UNITED STATES PATENT AND TRADEMARK OFFICE****Applicants:** Colgan, et al.**Examiner:** Mitchell, James M.**Serial No.:** 10/789,500**Group:** Art Unit 2813**Filed:** February 27, 2004**Docket:** YOR920030527US1 (8728-665)**For:** APPARATUS AND METHODS FOR COOLING**to EAC/ SEMICONDUCTOR INTEGRATED CIRCUIT PACKAGE STRUCTURES**

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313

**SUPPLEMENTAL AMENDMENT**

This is a Supplemental Amendment to the Amendment filed on 12 April 2007 in response to the Office Action mailed on January 12, 2007. Please amend the claims as follows: